

09/689,824

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 IBM Technical Disclosure Bulletins

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USPT	semiconductor near2 package	6629	<u>L1</u>

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Search Results - Record(s) 1 through 3 of 3 returned.☐ 1. Document ID: US 6268648 B1

L8: Entry 1 of 3

File: USPT

Jul 31, 2001

US-PAT-NO: 6268648

DOCUMENT-IDENTIFIER: US 6268648 B1

TITLE: Board for mounting semiconductor element, method for manufacturing the same, and semiconductor device

Full	Title	Citation	Front	Review	Classification	Date	Reference	Claims	KWIC	Draw Desc	Image
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☐ 2. Document ID: US 6022759 A

L8: Entry 2 of 3

File: USPT

Feb 8, 2000

US-PAT-NO: 6022759

DOCUMENT-IDENTIFIER: US 6022759 A

TITLE: Method for producing a semiconductor device, base member for semiconductor device and semiconductor device unit

Full	Title	Citation	Front	Review	Classification	Date	Reference	Claims	KWIC	Draw Desc	Image
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☐ 3. Document ID: US 5804467 A

L8: Entry 3 of 3

File: USPT

Sep 8, 1998

US-PAT-NO: 5804467

DOCUMENT-IDENTIFIER: US 5804467 A

TITLE: Semiconductor device and method of producing the same

Full	Title	Citation	Front	Review	Classification	Date	Reference	Claims	KWIC	Draw Desc	Image
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Search Results - Record(s) 1 through 10 of 14 returned.☐ 1. Document ID: US 6268648 B1

L7: Entry 1 of 14

File: USPT

Jul 31, 2001

US-PAT-NO: 6268648

DOCUMENT-IDENTIFIER: US 6268648 B1

TITLE: Board for mounting semiconductor element, method for manufacturing the same, and semiconductor device

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 2. Document ID: US 6188127 B1

L7: Entry 2 of 14

File: USPT

Feb 13, 2001

US-PAT-NO: 6188127

DOCUMENT-IDENTIFIER: US 6188127 B1

TITLE: Semiconductor packing stack module and method of producing the same

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 3. Document ID: US 6175151 B1

L7: Entry 3 of 14

File: USPT

Jan 16, 2001

US-PAT-NO: 6175151

DOCUMENT-IDENTIFIER: US 6175151 B1

TITLE: Film carrier tape, semiconductor assembly, semiconductor device, and method of manufacturing the same, mounted board, and electronic instrument

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 4. Document ID: US 6120906 A

L7: Entry 4 of 14

File: USPT

Sep 19, 2000

US-PAT-NO: 6120906
DOCUMENT-IDENTIFIER: US 6120906 A
TITLE: Insulated board for a wiring board

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 5. Document ID: US 6111306 A

L7: Entry 5 of 14

File: USPT

Aug 29, 2000

US-PAT-NO: 6111306
DOCUMENT-IDENTIFIER: US 6111306 A
TITLE: Semiconductor device and method of producing the same
and semiconductor device unit and method of producing the
same

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 6. Document ID: US 6022759 A

L7: Entry 6 of 14

File: USPT

Feb 8, 2000

US-PAT-NO: 6022759
DOCUMENT-IDENTIFIER: US 6022759 A
TITLE: Method for producing a semiconductor device, base
member for semiconductor device and semiconductor device
unit

Full	Title	Citation	Front	Review	Classification	Date	Reference
------	-------	----------	-------	--------	----------------	------	-----------

KWIC	Draw Desc	Image
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✓ ☐ 7. Document ID: US 5866942 A

L7: Entry 7 of 14

File: USPT

Feb 2, 1999

US-PAT-NO: 5866942
DOCUMENT-IDENTIFIER: US 5866942 A
TITLE: Metal base package for a semiconductor device

Full	Title	Citation	Front	Review	Classification	Date	Reference
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KWIC	Draw Desc	Image
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☐ 8. Document ID: US 5820014 A

L7: Entry 8 of 14

File: USPT

Oct 13, 1998